

Data Sheet	January 2002	

30A, 1200V Hyperfast Dual Diode

The RHRG30120CC is a hyperfast dual diode with soft recovery characteristics (t_{rr} < 65ns). It has half the recovery time of ultrafast diodes and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of high frequency switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

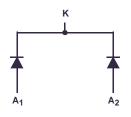
Formerly developmental type TA49041.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RHRG30120CC	TO-247	RHR30120C

NOTE: When ordering, use the entire part number.

Symbol



Features

•	Hyperfast with Soft Recovery<65ns
•	Operating Temperature
•	Reverse Voltage1200V

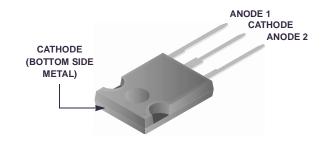
- · Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- · Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE TO-247



Absolute Maximum Ratings (Per Leg) $T_C = 25^{\circ}C$

	RHRG30120CC	UNITS	
Peak Repetitive Reverse VoltageVRRM	1200	V	
Working Peak Reverse Voltage	1200	V	
DC Blocking VoltageV _R	1200	V	
Average Rectified Forward Current	30	V	
$(T_C = 78^{\circ}C)$			
Repetitive Peak Surge Current I _{FRM}	60	V	
(Square Wave, 20kHz)			
Nonrepetitive Peak Surge Current	300	V	
(Halfwave, 1 Phase, 60Hz)			
Maximum Power Dissipation	125	W	
Avalanche Energy (See Figures 7 and 8)	30	mJ	
Operating and Storage Temperature	-65 to 175	°C	

RHRG30120CC

Electrical Specifications (Per Leg) $T_C = 25^{\circ}C$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V _F	I _F = 30A	-	-	3.2	V
	$I_F = 30A, T_C = 150^{\circ}C$	-	-	2.6	V
I _R	V _R = 1200V	-	-	250	μΑ
	$V_R = 1200V, T_C = 150^{\circ}C$	-	-	1	mA
t _{rr}	I _F = 1A, dI _F /dt = 100A/μs	-	-	65	ns
	$I_F = 30A$, $dI_F/dt = 100A/\mu s$	-	-	85	ns
ta	$I_F = 30A$, $dI_F/dt = 100A/\mu s$	-	48	-	ns
t _b	$I_F = 30A$, $dI_F/dt = 100A/\mu s$	-	22	-	ns
$R_{ heta JC}$		-	-	1.2	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

Typical Performance Curves

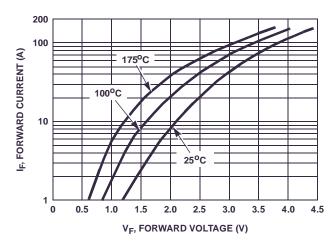


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

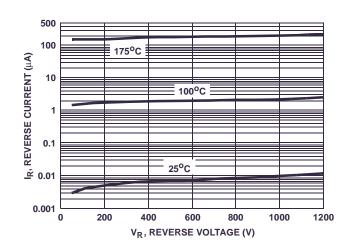


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

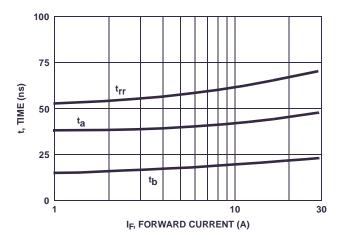


FIGURE 3. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

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FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

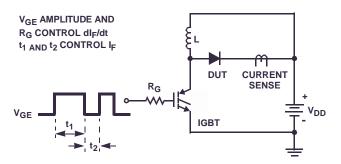


FIGURE 5. t_{rr} TEST CIRCUIT

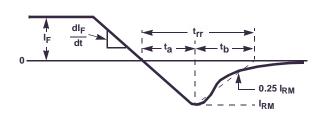


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

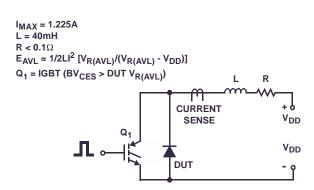


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

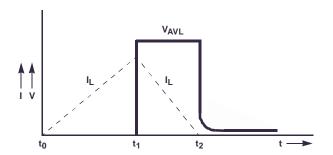


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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